



YEA SHIN TECHNOLOGY CO., LTD

GBU6A THRU GBU6M

GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current - 6.0 Amperes

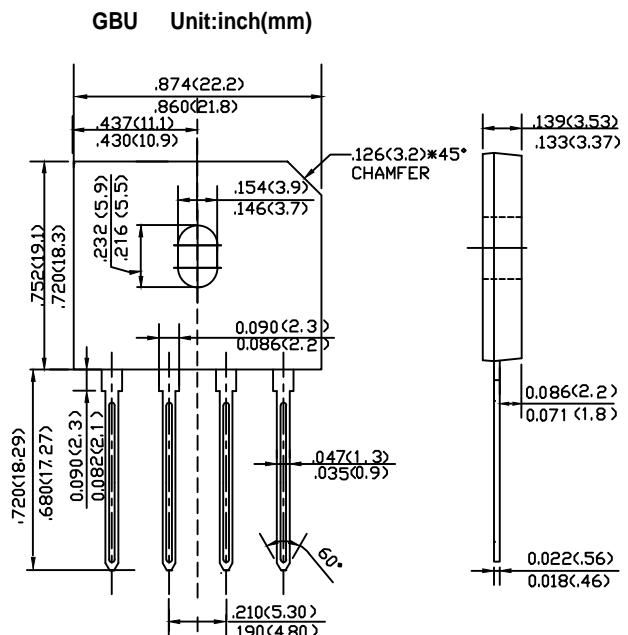
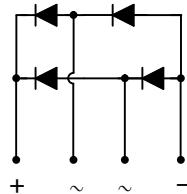


FEATURES

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Plastic material-UL flammability 94V-0

MECHANICAL DATA

- Case: GBU, molded plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Case
- Mounting Position: Any
- Marking: Type Number
- Lead Free: For ROHS / Lead Free Version



Maximum Rating and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single Phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

TYPE NUMBER	SYMBOL	GBU 6A	GBU 6B	GBU 6D	GBU 6G	GBU 6J	GBU 6K	GBU 6M	UNIT
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RWM}								
DC Blocking Voltage	V_{DC}								
RMS Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ $T_c=90^\circ\text{C}$	$I_{F(AV)}$						6.0		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}					150			A
Forward Voltage per element @ $I_F=3\text{A}$ @ $I_F=6\text{A}$	V_F					1.0	1.1		V
Peak Reverse Current @ $T_A=25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A=125^\circ\text{C}$	I_R					5.0	500		uA
I^2t Rating for fusing ($t < 8.3\text{ms}$)	I^2t					93			A^2s
Typical Junction Capacitance per leg (Note 2)	C_J					65			pF
Typical Thermal Resistance per leg (Note 3)	$R_{\theta JA}$					31			$^\circ\text{C}/\text{W}$
	$R_{\theta JL}$					10.9			
Operating and Storage Temperature Range	T_J, T_{STG}					-55 to +150			$^\circ\text{C}$

Note:1. Mounted on glass epoxy PC board with 1.3mm^2 solder pad.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

3. Device mounted on 50mm x 50mm x 1.6mm Cu Plate Heatsink.

DEVICE CHARACTERISTICS

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